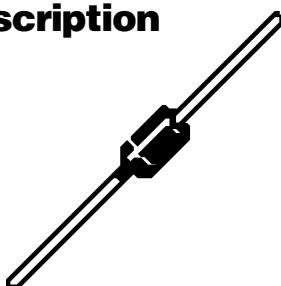
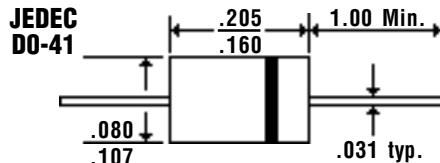


Description



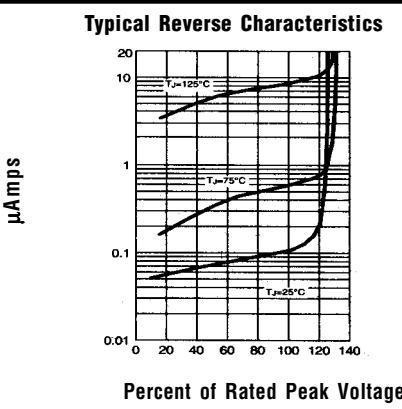
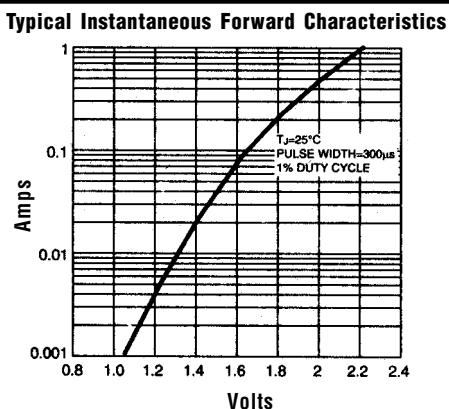
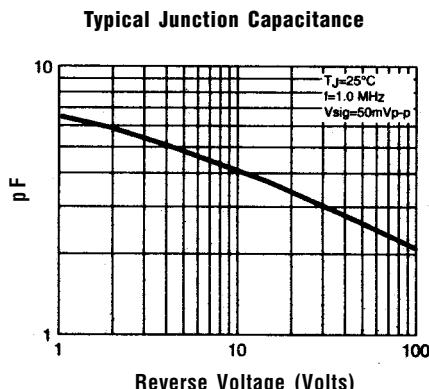
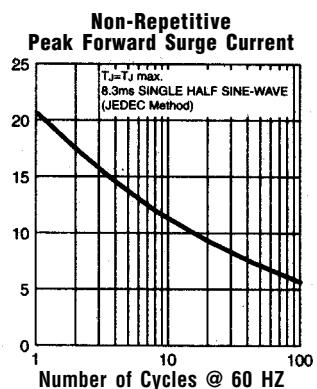
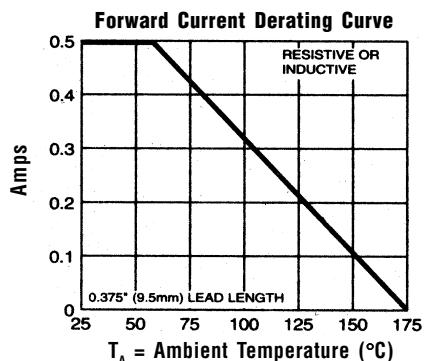
Mechanical Dimensions



Features

- **HIGH TEMPERATURE METALLURGICALLY BONDED CONSTRUCTION**
- **SINTERED GLASS CAVITY-FREE JUNCTION**
- **0.5 AMP OPERATION @ $T_A = 55^\circ\text{C}$, WITH NO THERMAL RUNAWAY**
- **TYPICAL $I_R < 0.2 \mu\text{Amp}$**

Electrical Characteristics @ 25°C.	RGP02-12E . . . -20E Series					Units
Maximum Ratings	RGP02-12E	RGP02-14E	RGP02-16E	RGP02-8E	RGP02-20E	
Peak Repetitive Reverse Voltage... V_{RRM}	1200	1400	1600	1800	2000	Volts
RMS Reverse Voltage... $V_{R(rms)}$	840	980	1120	1260	1400	Volts
DC Blocking Voltage... V_{DC}	1200	1400	1600	1800	2000	Volts
Average Forward Rectified Current... $I_F(av)$ Current 3/8" Lead Length @ $T_A = 55^\circ\text{C}$	0.5	Amps
Non-Repetitive Peak Forward Surge Current... I_{FSM} 8.3mS, ½ Sine Wave Superimposed on Rated Load	20	Amps
Forward Voltage @ 0.1A and 25°C... V_F	1.8	Volts
Full Load Reverse Current... $I_R(av)$ Full Cycle Average @ $T_A = 55^\circ\text{C}$	100	μAmps
DC Reverse Current... I_R @ Rated DC Blocking Voltage	$T_A = 25^\circ\text{C}$	5.0	μAmps
	$T_A = 125^\circ\text{C}$	50	μAmps
Typical Junction Capacitance... C_J (<i>Note 1</i>)	5.0	pF
Typical Thermal Resistance... R_{QJA} (<i>Note 2</i>)	65	$^\circ\text{C/W}$
Typical Reverse Recovery Time... t_{RR} (<i>Note 3</i>)	300	nS
Operating & Storage Temperature Range... T_J , T_{STRG}	-65 to 175	$^\circ\text{C}$



Ratings at
25 Deg. C ambient
temperature
unless otherwise
specified.

Single Phase Half
Wave, 60 Hz
Resistive or
Inductive Load.

For Capacitive
Load, Derate
Current by 20%.

- NOTES:**
1. Measured @ 1 MHZ and applied reverse voltage of 4.0V.
 2. Thermal Resistance from Junction to Ambient at 3/8" Lead Length, P.C. Board Mounted.
 3. Reverse Recovery Condition $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $I_{RR} = 0.25\text{A}$.